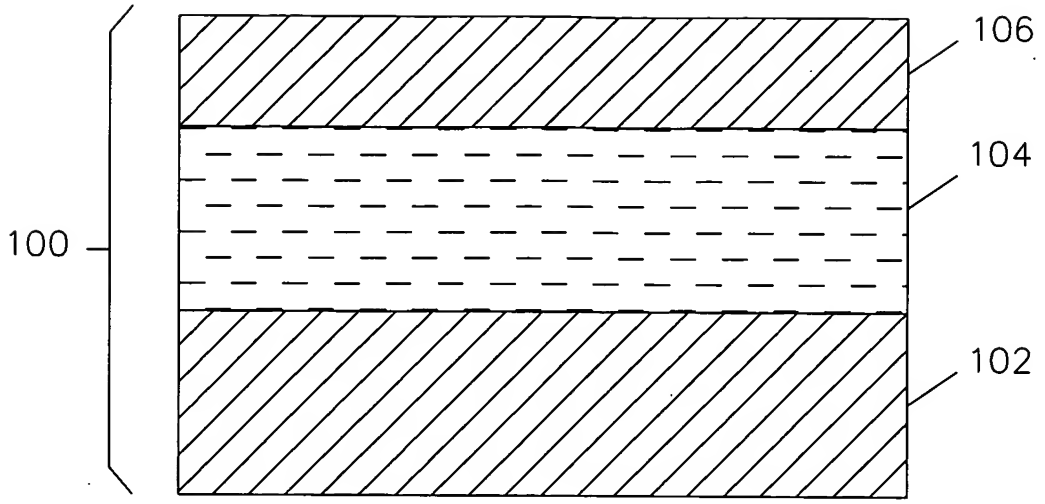

Fig. 1a

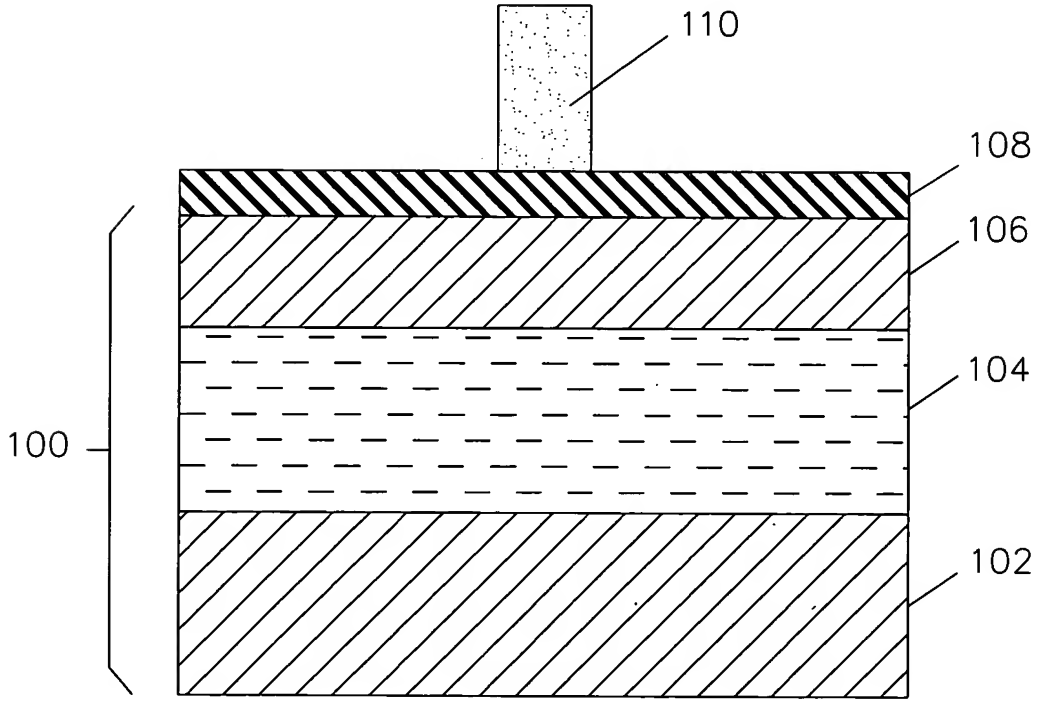

Fig. 1b

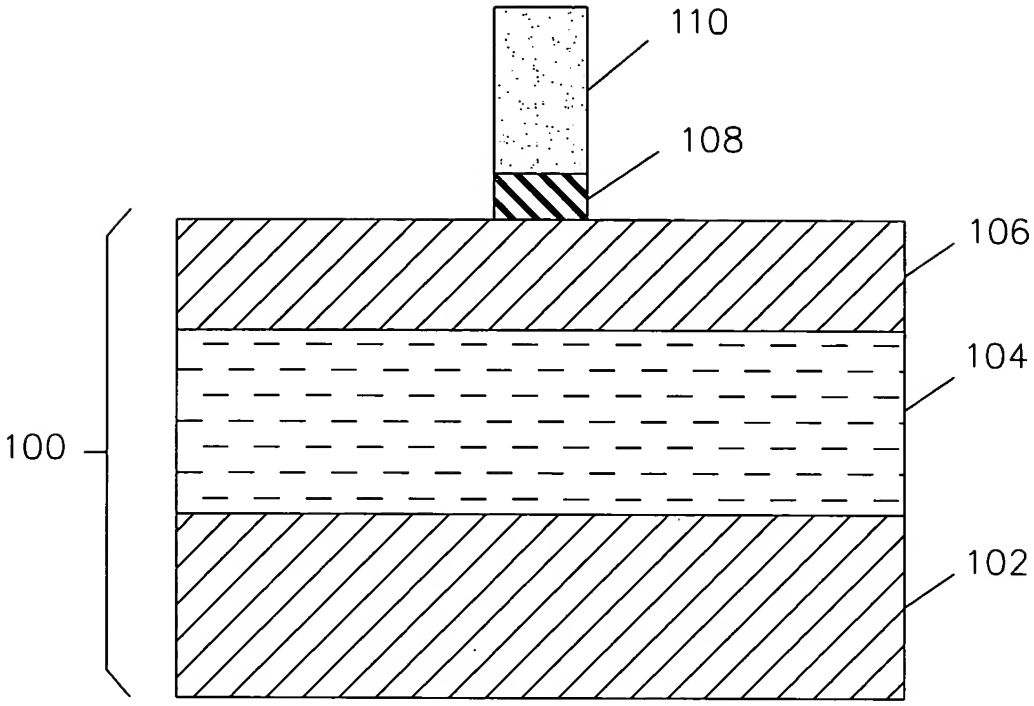

Fig. 1c

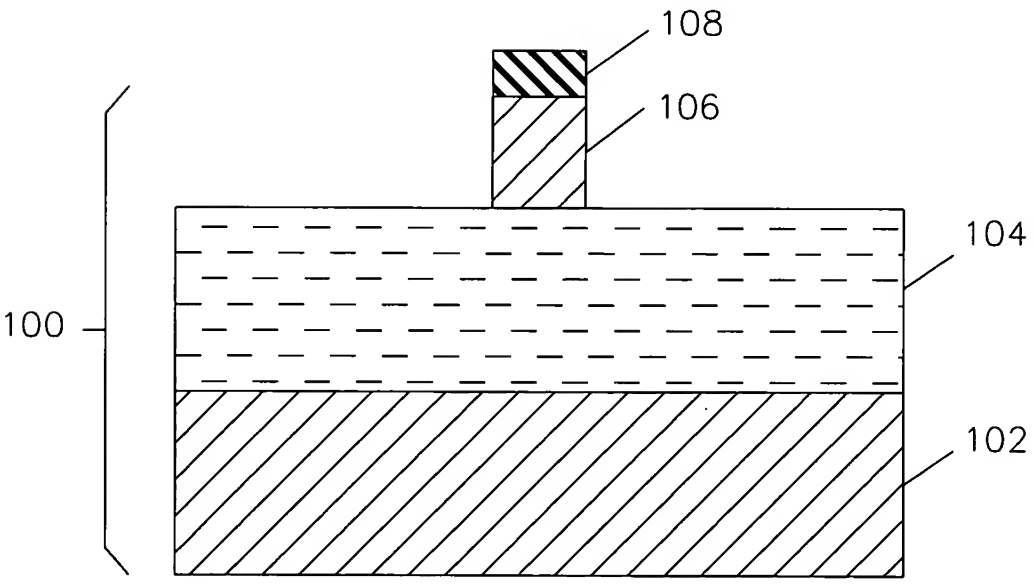

Fig. 1d

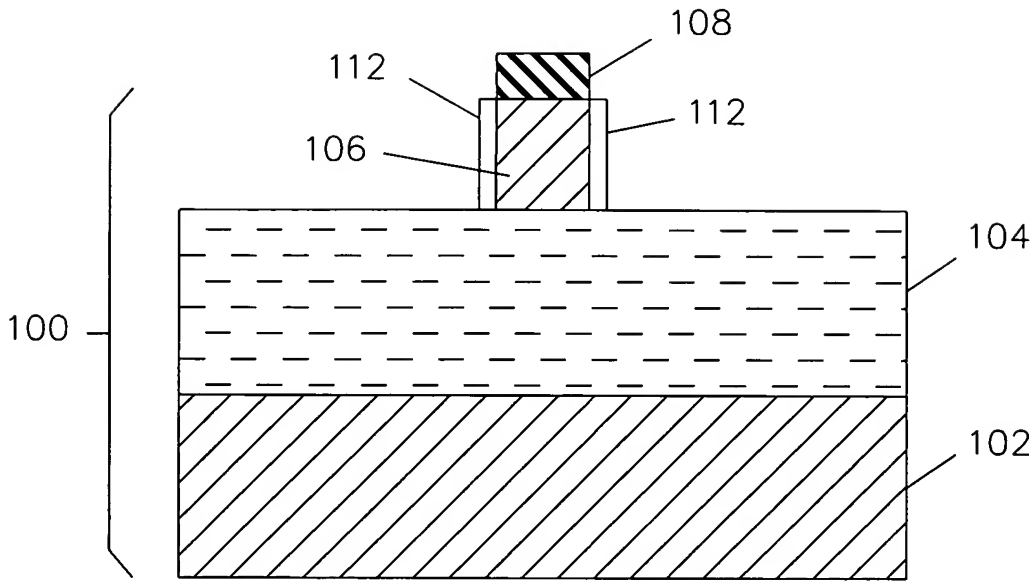

Fig. 1e

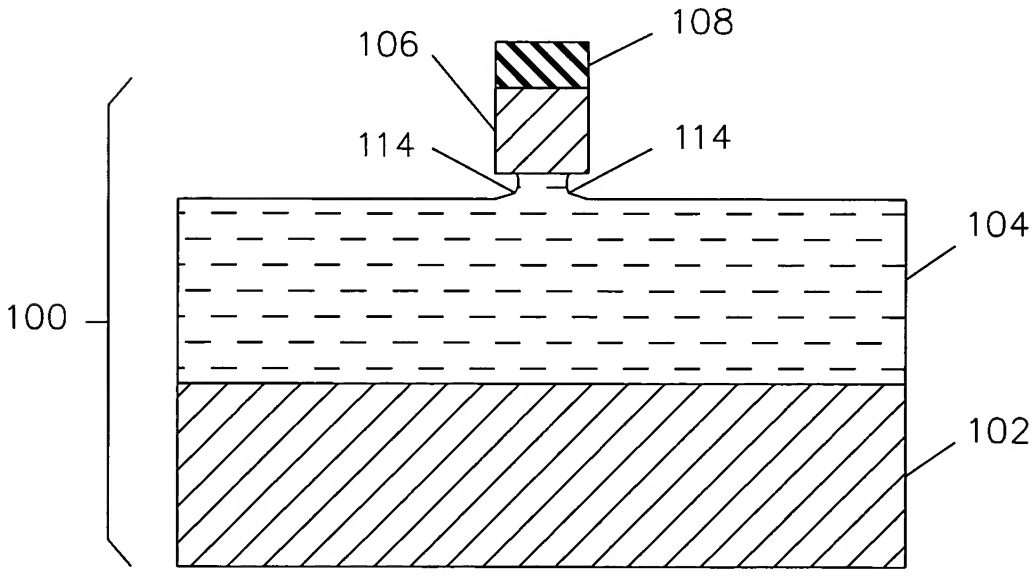

Fig. 1f

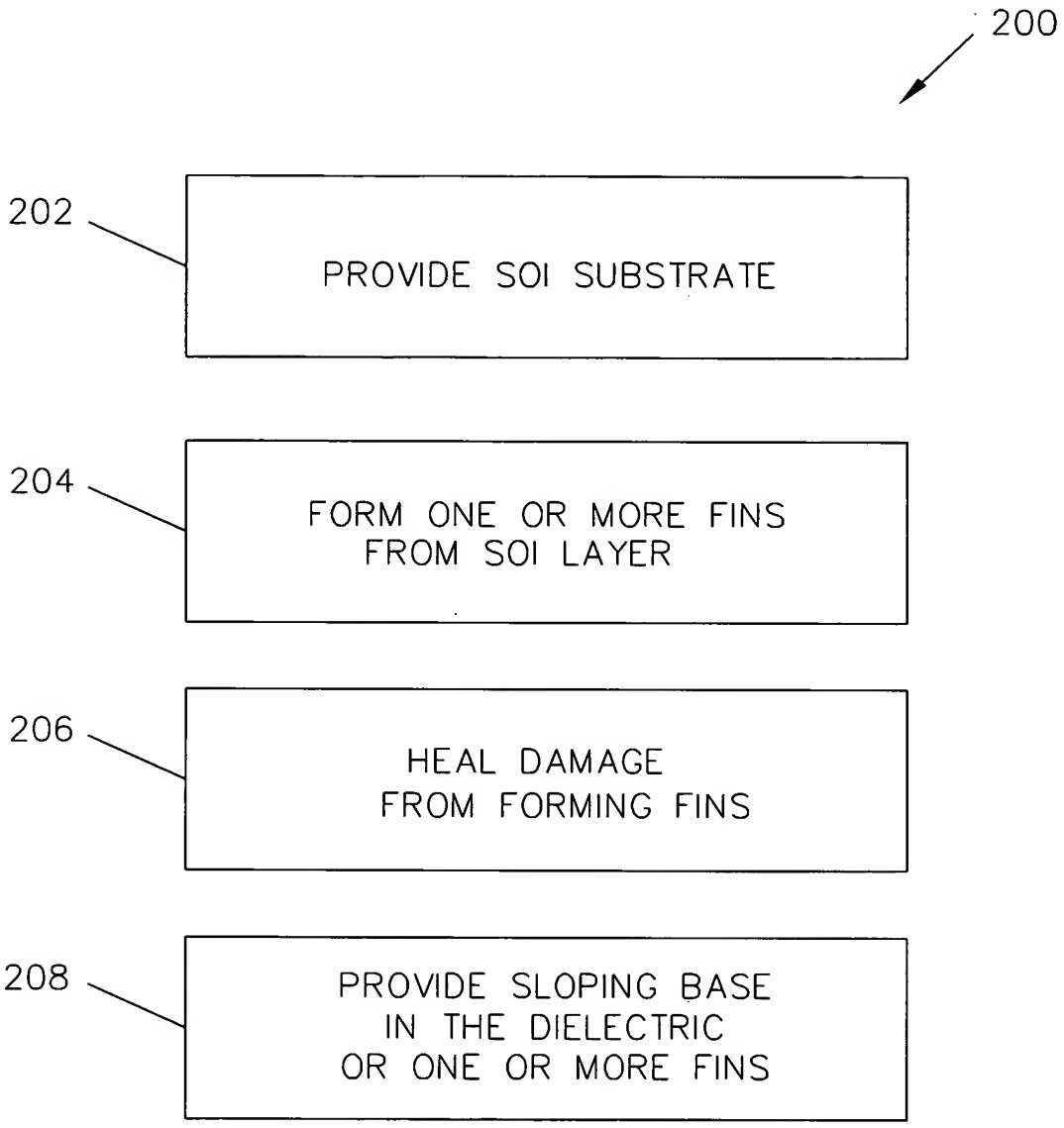
200
202
PROVIDE SOI SUBSTRATE
204
FORM ONE OR MORE FINS
FROM SOI LAYER
206
HEAL DAMAGE
FROM FORMING FINS
208
PROVIDE SLOPING BASE
IN THE DIELECTRIC
OR ONE OR MORE FINS

Fig. 2

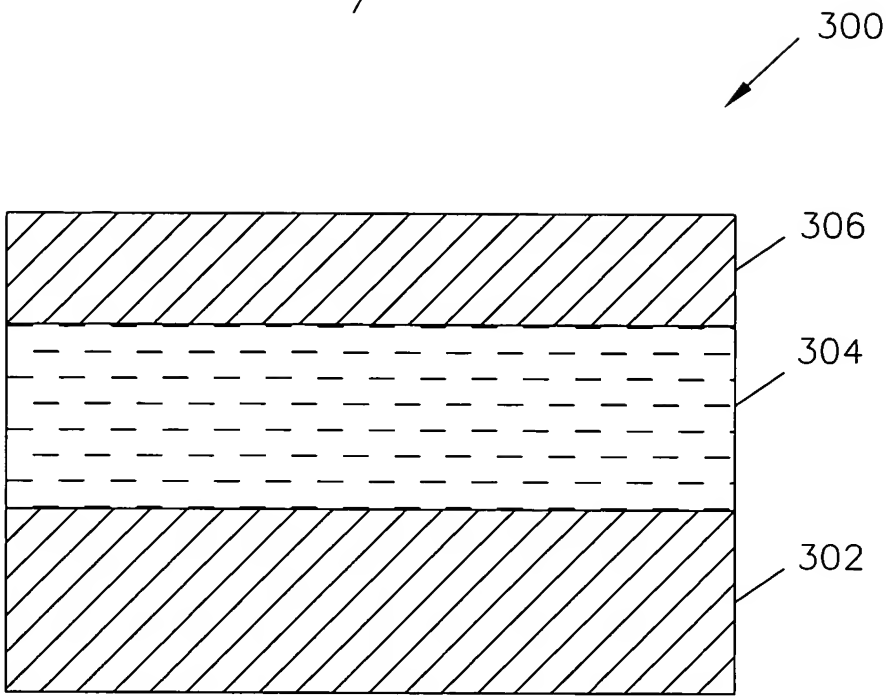

Fig. 3a

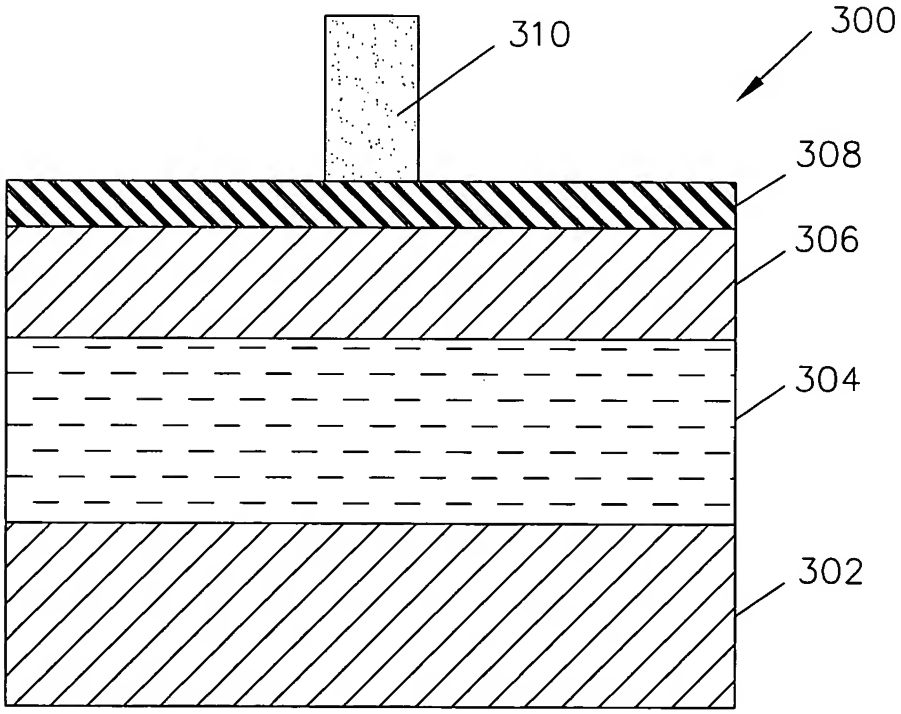

Fig. 3b

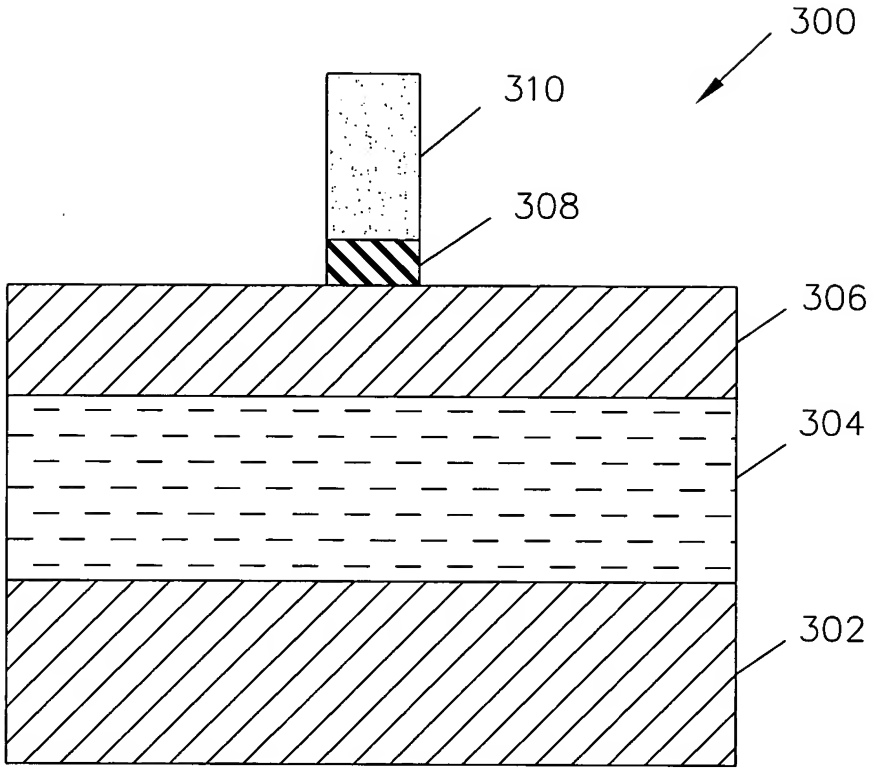

Fig. 3c

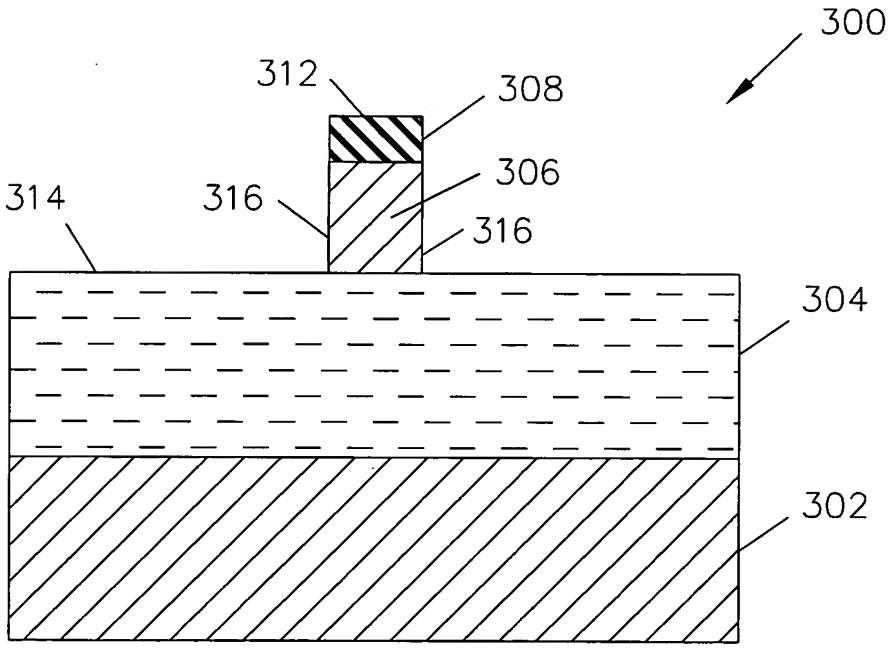

Fig. 3d

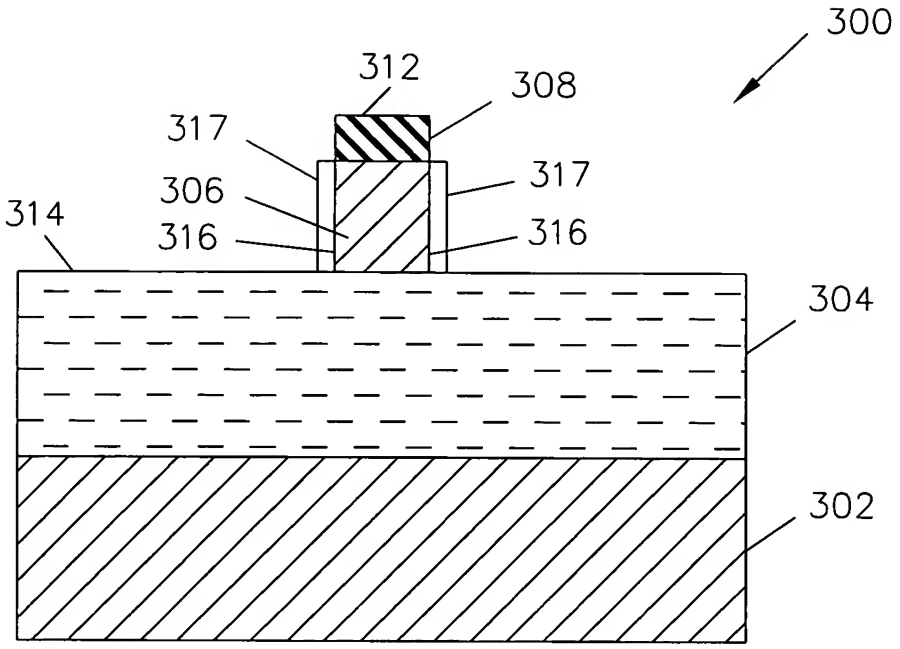
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Fig. 3e

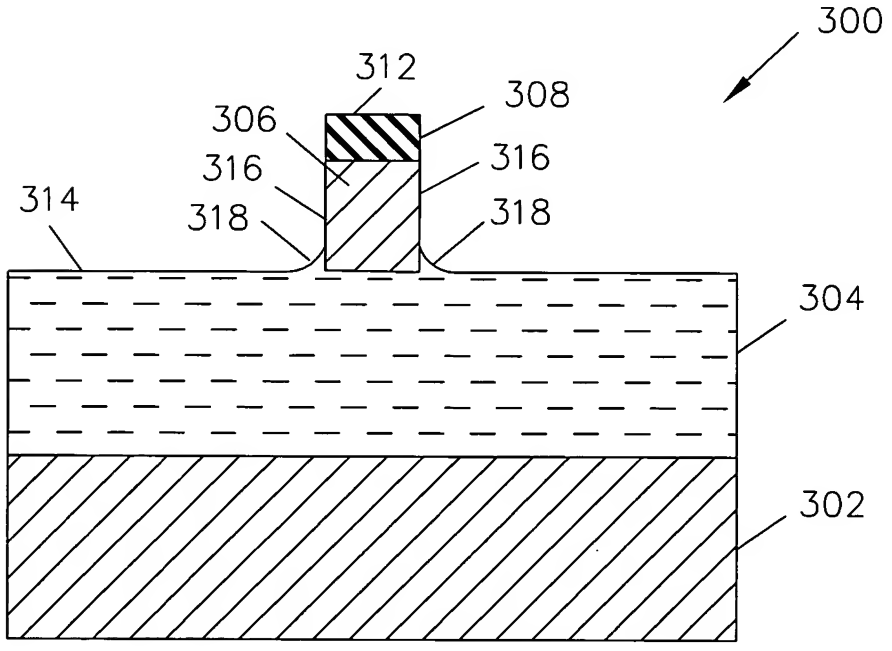
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Fig. 3f

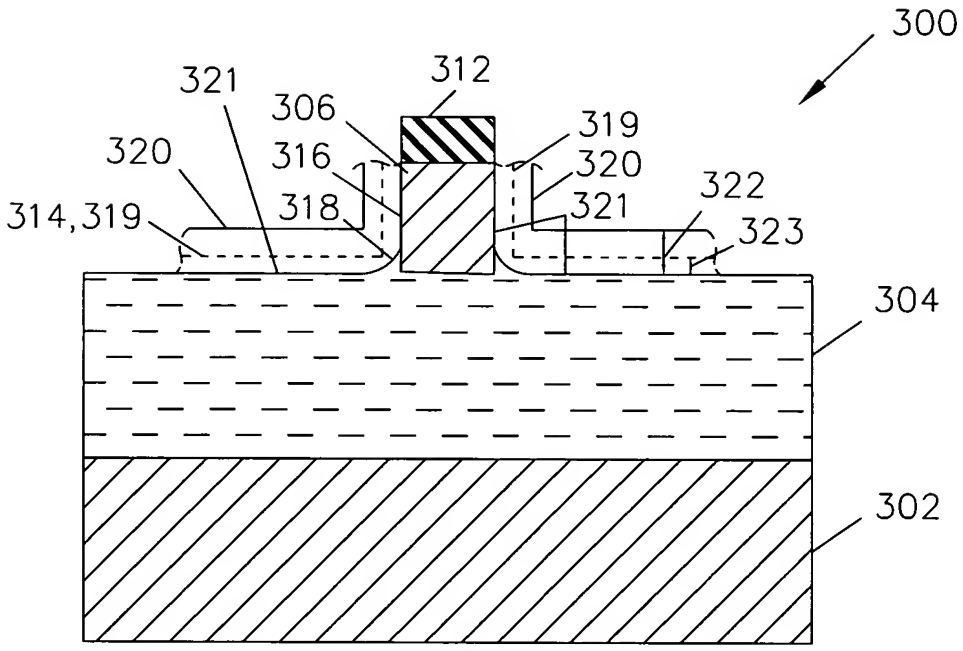

Fig. 4